PATENT ASSIGNMENT COVER SHEET

CORRECTIVE ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.2

SUBMISSION TYPE:

EPAS ID: PAT3443104

NATURE OF CONVEYANCE:		RELEASE OF SECURITY I	Corrective Assignment to correct the NATURE OF CONVEYANCE T RELEASE OF SECURITY INTEREST previously recorded on Reel 036082 Frame 0805. Assignor(s) hereby confirms the RELEASE OF SECURITY INTEREST.				
CONVEYING PARTY D	ΑΤΑ						
		Name	Execution Date				
SILICON VALLEY BAN	K		07/10/2015				
RECEIVING PARTY D	ATA						
Name:	PLATEA	PLATEAU DATA SERVICES, LLC					
Street Address:	185 MAI	DISON AVENUE					
City:	NEW YO	NEW YORK					
State/Country:	NEW YC	NEW YORK					
Postal Code:	10016						
	I						
PROPERTY NUMBERS	6 Total: 4						
Property Type		Number					
Patent Number: 796		7966564					
Patent Number: 8296		3296176					
Application Number: 1316		3164585					
•••		3657507					
CORRESPONDENCE I	ΔΑΤΑ						
Fax Number:	(4	404)572-5135					
•		the e-mail address first; if that					
using a fax number, if provided; Phone: 40		; if that is unsuccessiul, it will b 104-572-3493	e sent via US mail.				
Email:		osborne@kslaw.com					
Correspondent Name:		AREN OSBORNE, SENIOR PAP					
Address Line 1:							
Address Line 2:		(ING & SPALDING LLP	-				
Address Line 4:							
ATTORNEY DOCKET N	UMBER:	18876.015063					
		+	KAREN OSBORNE				
		KAREN OSBORNE					
NAME OF SUBMITTER: SIGNATURE:		//Karen Osborne//					

Total Attachments: 4

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PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

SUBMISSION TYPE:		NEW ASSIGNMENT							
NATURE OF CONVEYANCE:		SECURITY INTEREST	SECURITY INTEREST						
CONVEYING PARTY	DATA								
		Name	Execution Date]					
SILICON VALLEY BANK	*****		07/10/2015]					
RECEIVING PARTY D	RECEIVING PARTY DATA								
Name:	Name: PLATEAU DATA SERVICES, LLC								
Street Address:	185 MADISON AVE	NUE							
City:	NEW YORK								
State/Country:	NEW YORK								
Postal Code:	10016								
PROPERTY NUMBERS Total: 4									
Patent Number:	796	6564							
Patent Number:		96176							
Application Number:	131	4585							
Application Number:	136	07							
Fax Number: (049572-5155 Phone: 404-572-5493 Email: kobome@kklaw.com Correspondent to the e-mail address first; if that is unsuccessful, if will be sent sing a fax number, if provided; if that is unsuccessful, if will be sent via US Mail. Correspondent Name: KAREN KSBORNE RESINOR PARALEGAL Address Line 1: H300 FPACHTIREE STREET, N.E. Address Line 2: KING & SPALIDHOO LIP Address Line 1: KING & SPALIDHOO LIP Address Line 2: KING & SPALIDHOO LIP Address Line 1: KINA GEORGHA 30309									
ATTORNEY DOCKET NU	MBER:	18876.015063							
NAME OF SUBMITTER:		KAREN OSBORNE							
Signature:		//Karen Osborne//							
Date:		07/14/2015							
Total Attachments: 3 source=GSO_Zeta - Executed Patent Release (Plateau)#page1.tif source=GSO_Zeta - Executed Patent Release (Plateau)#page2.tif source=GSO_Zeta - Executed Patent Release (Plateau)#page3.tif									
RECEIPT INFORMATION									
EPAS ID: Receipt Date:		PAT3438340 07/14/2015							

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PATENT

Execution Version

RELEASE OF SECURITY INTEREST IN PATENTS

THIS RELEASE OF SECURITY INTEREST IN PATENTS ("Release") is made as of this 10th day of July 2015, by SILICON VALLEY BANK ("Lender"), in favor of PLATEAU DATA SERVICES, LLC, a Delaware limited liability company) ("Company").

Reference is made to that certain Payoff Letter dated as of July 10, 2015 by and among Lender, the Company and certain affiliates of the Company party thereto (the "Payoff Letter").

FOR GOOD AND VALUABLE CONSIDERATION, the receipt and adequacy of which are hereby acknowledged, subject to the terms and conditions of the Payoff Letter, Lender hereby releases its liens on and security interests in the patents listed on <u>Schedule A</u> attached hereto and made a part hereof, which liens and security interests were established under and pursuant to that certain Patent Security Agreement dated January 16, 2014 executed by Company in favor of Lender and recorded with the United States Patent and Trademark Office on December 17, 2010 at reel/frame 032153/0097.

[Signature Page Follows]

PATENT REEL: 036128 FRAME: 0966

DMSLIBRARY01:26133550.1

IN WITNESS HEREOF, Agent has caused this Release to be duly executed by its duly authorized officer as of the day and year first above written.

SILICON VALLEY BANK

By: Name: for S Title:_____

SCHEDULE A

PATENT REGISTRATIONS/APPLICATIONS

PATENT	SERIAL NUMBER	FILE DATE	PATENT NUMBER	ISSUE DATE	OWNER INFORMATION
Web page server process using visitor context and page features to select optimized web pages for display	12117325	05/08/08	7966564	06/21/11	Plateau Data Services, LLC
Matching visitors as leads to lead buyers	12688184	01/15/10	8296176	10/23/12	Plateau Data Services, LLC
Using visitor context and web page features to select web pages for display	13164585 20110246906	06/20/11	NA	NA	Plateau Data Services, LLC
Matching lead filters to visitors	13657507	10/22/12	NA	NA	Plateau Data Services, LLC